Electronic Patent Application Fee Transmittal							
Application Number:	10722174						
Filing Date:	25-Nov-2003						
Title of Invention:	On-wafer electrochemical deposition plating metrology process and apparatus						
First Named Inventor/Applicant Name:	MacKenzie King						
Filer:	Steven John Hultquist						
Attorney Docket Number:	ATMI-688						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			120